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INTERNATIONAL STANDARD



**Electromagnetic compatibility (EMC) –
Part 4-24: Testing and measurement techniques – Test methods for protective
devices for HEMP conducted disturbance**

INTERNATIONAL
ELECTROTECHNICAL
COMMISSION

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**Electromagnetic compatibility (EMC) –
Part 4-24: Testing and measurement techniques – Test methods for protective
devices for HEMP conducted disturbance**



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INTERNATIONAL ELECTROTECHNICAL COMMISSION

ELECTROMAGNETIC COMPATIBILITY (EMC) –

**Part 4-24: Testing and measurement techniques –
Test methods for protective devices
for HEMP conducted disturbance**

FOREWORD

- 1) The International Electrotechnical Commission (IEC) is a worldwide organization for standardization comprising all national electrotechnical committees (IEC National Committees). The object of IEC is to promote international co-operation on all questions concerning standardization in the electrical and electronic fields. To this end and in addition to other activities, IEC publishes International Standards, Technical Specifications, Technical Reports, Publicly Available Specifications (PAS) and Guides (hereafter referred to as "IEC Publication(s)"). Their preparation is entrusted to technical committees; any IEC National Committee interested in the subject dealt with may participate in this preparatory work. International, governmental and non-governmental organizations liaising with the IEC also participate in this preparation. IEC collaborates closely with the International Organization for Standardization (ISO) in accordance with conditions determined by agreement between the two organizations.
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This consolidated version of the official IEC Standard and its amendment has been prepared for user convenience.

IEC 61000-4-24 edition 2.1 contains the second edition (2015-11) [documents 77C/245/FDIS and 77C/250/RVD] and its amendment 1 (2023-08) [documents 77C/330/FDIS and 77C/331/RVD].

In this Redline version, a vertical line in the margin shows where the technical content is modified by amendment 1. Additions are in green text, deletions are in strikethrough red text. A separate Final version with all changes accepted is available in this publication.

International Standard IEC 61000-4-24 has been prepared by subcommittee 77C: High power transient phenomena, of IEC technical committee 77: Electromagnetic compatibility.

It forms Part 4-24 of IEC 61000. It has the status of a basic EMC publication in accordance with IEC Guide 107.

This second edition constitutes a technical revision.

This edition includes the following significant technical changes with respect to the previous edition:

- a) A new Clause 5: Measurement method for HEMP combination filters, which contains 5.1 Verification setup, 5.2 Measurement setup, 5.3 Measurement instrument, 5.4 Test modes, 5.5 Measurement procedures, 5.6 Evaluation of test results, which introduced performance criteria of filter, and 5.7 Test report.
- b) A new informative Annex A: Investigation for the establishment of a measurement setup, which was based on Clause 5.
- c) A new informative Annex B: Test method for the quantitative determination of the direct response behaviours of a coaxial surge protector.

This publication has been drafted in accordance with the ISO/IEC Directives, Part 2.

A list of all parts in the IEC 61000 series, published under the general title *Electromagnetic compatibility (EMC)*, can be found on the IEC website.

The committee has decided that the contents of this document and its amendment will remain unchanged until the stability date indicated on the IEC website under webstore.iec.ch in the data related to the specific document. At this date, the document will be

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INTRODUCTION

This standard is part of the IEC 61000 series of standards, according to the following structure:

Part 1: General

- General considerations (introduction, fundamental principles)
- Definitions, terminology

Part 2: Environment

- Description of the environment
- Classification of the environment
- Compatibility levels

Part 3: Limits

- Emission limits
- Immunity limits

Part 4: Testing and measurement techniques

- Measurement techniques
- Testing techniques

Part 5: Installation and mitigation guidelines

- Installation guidelines
- Mitigation methods and devices

Part 6: Generic standards

Part 9: Miscellaneous

Each part is further subdivided into several parts, published either as international standards, as technical specifications or technical reports, some of which have already been published as sections. Others will be published with the part number followed by a dash and a second number identifying the subdivision (example: IEC 61000-6-1).

The IEC has initiated the preparation of standardized methods to protect civilian society from the effects of high power electromagnetic (HPEM) environments. Such effects could disrupt systems for communications, electric power, information technology, etc.

This part of IEC 61000 is an international standard that establishes the required test procedures for protective devices for HEMP conducted disturbance, such as gas discharge tubes, varistors, two-port SPDs and HEMP combination filters.

The application of this standard is, however, not dependent on access to other sections and parts of the IEC 61000, except for those specifically referred to.

ELECTROMAGNETIC COMPATIBILITY (EMC) –

Part 4-24: Testing and measurement techniques – Test methods for protective devices for HEMP conducted disturbance

1 Scope

This part of IEC 61000 deals with methods for testing protective devices for HEMP conducted disturbance. It includes two-terminal elements, such as gas discharge tubes, varistors, and two-port SPDs, such as HEMP combination filters. It covers testing of voltage breakdown and voltage-limiting characteristics but also methods to measure the residual voltage and/or the residual current, peak rate of rise and root action for the case of very fast changes of voltage and current as a function of time.

This standard does not cover insertion loss measurement methods.

2 Normative references

The following documents, in whole or in part, are normatively referenced in this document and are indispensable for its application. For dated references, only the edition cited applies. For undated references, the latest edition of the referenced document (including any amendments) applies.

IEC 61000-2-10:2021, *Electromagnetic compatibility (EMC) – Part 2-10: Environment – Description of HEMP environment – Conducted disturbance*

FINAL VERSION



**Electromagnetic compatibility (EMC) –
Part 4-24: Testing and measurement techniques – Test methods for protective
devices for HEMP conducted disturbance**

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Part 4-24: Testing and measurement techniques – Test methods for protective devices for HEMP conducted disturbance

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